## DATA SHEET

## 74ABT16260/74ABTH16260 12-bit to 24-bit multiplexed D-type latches (3-State)

PHILIPS

## FEATURES

- ESD protection exceeds 2000V per Mil-Std-883C, Method 3015; exceeds 200 V using machine model ( $\mathrm{C}=200 \mathrm{pF}, \mathrm{R}=0$ ).
- Latch-up performance exceeds 500mA per JEDEC Standard JESD-17.
- Distributed $\mathrm{V}_{\mathrm{CC}}$ and GND pin configuration minimizes high-speed switching noise.
- Flow-through architecture optimizes PCB layout.
- High-drive outputs ( $-32 \mathrm{~mA} \mathrm{I}_{\mathrm{OH}}, 64 \mathrm{~mA} \mathrm{I}_{\mathrm{OL}}$ ).
- 74ABTH16260 incorporates bus-hold inputs which eliminate the need for external pull-up resistors.
- Package options:
- 56-pin plastic Shrink Small-Outline Package (SSOP)
- 56-pin plastic Thin Shrink Small-Outline Package (TSSOP)


## DESCRIPTION

The 74ABT16260/74ABTH16260 is a 12 -bit to 24 -bit multiplexed D-type latch used in applications where two separate data paths must be multiplexed onto, or demultiplexed from, a single data path. Typical applications include multiplexing and/or demultiplexing of address and data information in microprocessor or bus-interface applications. This device is alto useful in memory-interleaving applications.

Three 12-bit I/O ports (A1-A12, 1B1-1B12, and 2B1-2B12) are available for address and/or data transfer. The output enable (OE1B, $\overline{O E} 2 \mathrm{~B}$, and $\overline{O E A}$ ) inputs control the bus transceiver functions. The OE1B and OE2B control signals also allow bank control in the A to $B$ direction

Address and/or data information can be stored using the internal storage latches. The latch enable (LE1B, LE2B, LEA1B, and LEA2B) inputs are used to control data storage. When the latch enable input is high, the latch is transparent. When the latch enable input goes low, the data present at the inputs is latched and remains latched until the latch enable input is returned high.

To ensure the high-impedance state during power-up or power-down, $\overline{O E}$ should be tied to $\mathrm{V}_{\mathrm{CC}}$ through a pull-up resistor; the minimum value of the resistor is determined by the current sinking capability of the driver.

The 74ABTH incorporates the bus hold feature. The 74ABT does not include bus hold feature. Both parts are available in 56 -pin SSOP and TSSOP.

## QUICK REFERENCE DATA

| SYMBOL | PARAMETER | CONDITIONS <br> $\mathbf{T}_{\text {amb }}=\mathbf{2 5} \mathbf{C} ; \mathbf{G N D}=\mathbf{0 V}$ | TYPICAL | UNIT |
| :---: | :--- | :---: | :---: | :---: |
| $\mathrm{t}_{\text {PLH }}$ | Propagation delay | $\mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}$ | 2.8 | ns |
| $\mathrm{t}_{\text {PHL }}$ | nAx to nBx nBx to nAx | $\mathrm{V}_{\mathrm{I}}=0 \mathrm{~V}$ or $\mathrm{V}_{\mathrm{CC}}$ | 2.5 | n |
| $\mathrm{C}_{\mathrm{IN}}$ | Input capacitance | $\mathrm{V}_{\text {I/ }}=0 \mathrm{~V}$ or 5.0 V | 4 | pF |
| $\mathrm{C}_{\mathrm{OUT}}$ | Output capacitance | Outputs disabled | 6 | pF |
| $\mathrm{I}_{\mathrm{CCZ}}$ | Total supply current |  | 100 | $\mu \mathrm{~A}$ |

## ORDERING INFORMATION

| PACKAGES | TEMPERATURE RANGE | OUTSIDE NORTH AMERICA | NORTH AMERICA | DWG NUMBER |
| :--- | :---: | :---: | :---: | :---: |
| 56-Pin Plastic SSOP Type III | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 74 ABT16260 DL | BT16260 DL | SOT371-1 |
| 56-Pin Plastic TSSOP Type II | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $74 \mathrm{ABT16260} \mathrm{DGG}$ | BT16260 DGG | SOT364-1 |
| 56-Pin Plastic SSOP Type III | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $74 \mathrm{ABTH16260} \mathrm{DL}$ | BH16260 DL | SOT371-1 |
| 56-Pin Plastic TSSOP Type II | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $74 \mathrm{ABTH16260} \mathrm{DGG}$ | BH16260 DGG | SOT364-1 |

## PIN DESCRIPTION

| PIN NUMBER | SYMBOL | FUNCTION |
| :---: | :---: | :--- |
| $8,9,10,12,13,14,15,16,17,19,20,21$ | An | Data inputs/outputs (A) |
| $23,24,26,31,33,34,36,37,38,40,41,42$ | 1 Bn | Data inputs/outputs (B1) |
| $6,5,3,54,52,51,49,48,47,45,44,43$ | 2 Bn | Data inputs/outputs (B2) |
| $1,29,56$ | $\overline{\text { OEA, OE1B }}$, OE2B | Output enable input (active low) |
| $2,27,30,55$ | LE1B, LE2B, LEA1B, LEA2B | Latch enable inputs |

## 12-bit to 24-bit multiplexed D-type latches (3-State)

PIN CONFIGURATION


FUNCTION TABLES
$B$ to $A(\overline{O E B}=H)$

| INPUTS |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 1B | 2B | SEL | LE1B | LE2B | OEA | OUTPUT |
| H | X | H | H | X | L | H |
| L | X | H | H | X | L | L |
| X | X | H | L | X | L | A0 |
| X | H | L | X | H | L | H |
| X | L | L | X | H | L | L |
| X | X | L | X | L | L | AO |
| X | X | X | X | X | H | Z |

A to B $(O E A=H)$

| INPUTS |  |  |  |  | OUTPUT |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| A | LEA1B | LEA2B | OE1B | OE2B | 1B | 2B |
| H | H | H | L | L | H | H |
| L | H | H | L | L | L | L |
| H | H | L | L | L | H | 2B0 |
| L | H | L | L | L | L | 2B0 |
| H | L | H | L | L | $1 B 0$ | H |
| L | L | H | L | L | 1 B0 | L |
| X | L | L | L | L | 1 B0 | 2B0 |
| X | X | X | H | H | Z | Z |
| X | X | X | L | H | Active | Z |
| X | X | X | H | L | Z | Active |
| X | X | X | L | L | Active | Active |

## 12-bit to 24-bit multiplexed D-type latches (3-State)

LOGIC DIAGRAM (POSITIVE LOGIC)


## 12-bit to 24-bit multiplexed D-type latches (3-State)

## ABSOLUTE MAXIMUM RATINGS

Over operating free-air temperature range (unless otherwise specified) ${ }^{1}$

| SYMBOL | PARAMETER | CONDITIONS | LIMITS |  | UNIT |
| :--- | :--- | :---: | :---: | :---: | :---: |
|  |  |  |  | MIN |  |
|  |  |  |  |  |
| $\mathrm{V}_{\mathrm{CC}}$ | Supply voltage range |  | -0.5 | 7 | V |
| $\mathrm{~V}_{\mathrm{I}}$ | Input voltage range | see Note 2 | -0.5 | 7 | V |
| $\mathrm{~V}_{\mathrm{O}}$ | Voltage range applied to any output in the high state or power-off state |  | -0.5 | 5.5 | V |
| $\mathrm{I}_{\mathrm{O}}$ | Current into any output in the low state |  |  | 128 | mA |
| $\mathrm{I}_{\mathrm{IK}}$ | Input clamp current | $\mathrm{V}_{\mathrm{I}}<0$ |  | -18 | mA |
| $\mathrm{I}_{\mathrm{OK}}$ | Output clamp current | $\mathrm{V}_{\mathrm{O}}<0$ |  | -50 | mA |
|  | Maximum power dissipation at $\mathrm{T}_{\text {amb }}=55^{\circ} \mathrm{C}$ (in still air) | see Note 3 |  | 1.4 | W |
| $\mathrm{~T}_{\text {stg }}$ | Storage temperature range |  | -65 | +150 | ${ }^{\circ} \mathrm{C}$ |

## NOTES:

1. Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "Recommended Operating Conditions" is not implied. Exposure to absolute maximum rated conditions for extended periods may affect device reliability.
2. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
3. The maximum package power dissipation is calculated using a junction temperature of $150^{\circ} \mathrm{C}$ and a board trace length of 750 mils.

## RECOMMENDED OPERATING CONDITIONS ${ }^{1}$

| SYMBOL | PARAMETER |  | LIMITS |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | MAX |  |
| $\mathrm{V}_{\mathrm{CC}}$ | Supply voltage |  | 4.5 | 5.5 | V |
| $\mathrm{V}_{\mathrm{IH}}$ | High-level input voltage |  | 2 |  | V |
| $\mathrm{V}_{\text {IL }}$ | Low-level input voltage |  |  | 0.8 | V |
| $\mathrm{V}_{1}$ | Input voltage |  | 0 | $\mathrm{V}_{\mathrm{CC}}$ | V |
| IOH | High-level output current |  |  | -32 | mA |
| l OL | Low-level output current |  |  | 64 | mA |
| $\Delta \mathrm{t} \Delta / \mathrm{v}$ | Input transition rise or fall rate | Outputs enabled |  | 10 | $\mathrm{ns} / \mathrm{V}$ |
| $\Delta t \Delta / V_{\text {CC }}$ | Power-up ramp rate |  | 200 |  | $\mu \mathrm{s} / \mathrm{V}$ |
| $\mathrm{T}_{\text {amb }}$ | Operating free-air temperature |  | -40 | +85 | ${ }^{\circ} \mathrm{C}$ |

## NOTE:

1. Unused or floating inputs must be held high or low.

## DC ELECTRICAL CHARACTERISTICS

| SYMBOL | PARAMETER | TEST CONDITIONS |  | LIMITS |  |  |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | $\mathrm{T}_{\text {amb }}=+25^{\circ} \mathrm{C}$ |  |  | $\begin{gathered} \mathrm{T}_{\mathrm{amb}}=-40^{\circ} \mathrm{C} \\ \text { to }+85^{\circ} \mathrm{C} \end{gathered}$ |  |  |
|  |  |  |  | Min | Typ | Max | Min | Max |  |
| $\mathrm{V}_{\mathrm{IK}}$ | Input clamp voltage | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V} ; \mathrm{I}_{\mathrm{IK}}=-18 \mathrm{~mA}$ |  |  | -0.8 | -1.2 |  | -1.2 | V |
| $\mathrm{V}_{\mathrm{OH}}$ | High-level output voltage | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V} ; \mathrm{I}_{\mathrm{OH}}=-3 \mathrm{~mA} ; \mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{IL}}$ or $\mathrm{V}_{\mathrm{IH}}$ |  | 2.5 | 2.9 |  | 2.5 |  | V |
|  |  | $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V} ; \mathrm{I}_{\mathrm{OH}}=-3 \mathrm{~mA} ; \mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{IL}}$ or $\mathrm{V}_{\mathrm{IH}}$ |  | 3.0 | 3.4 |  | 3.0 |  | V |
|  |  | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V} ; \mathrm{I}_{\mathrm{OH}}=-32 \mathrm{~mA} ; \mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{IL}}$ or $\mathrm{V}_{\mathrm{IH}}$ |  | 2.0 | 2.4 |  | 2.0 |  | V |
| $\mathrm{V}_{\text {OL }}$ | Low-level output voltage | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$; $\mathrm{IOL}=64 \mathrm{~mA} ; \mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{IL}}$ or $\mathrm{V}_{\mathrm{IH}}$ |  |  | 0.42 | 0.55 |  | 0.55 | V |
| 1 | Input leakage current | $\mathrm{V}_{\mathrm{CC}}=5.5 \mathrm{~V} ; \mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{CC}}$ or GND | Control pins |  | $\pm 0.01$ | $\pm 1$ |  | $\pm 1$ | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{\mathrm{CC}}=5.5 \mathrm{~V} ; \mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{CC}}$ or GND | Data pins |  |  | $\pm 3$ |  | $\pm 5$ | $\mu \mathrm{A}$ |
| Imold | Bus Hold current | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V} ; \mathrm{V}_{\mathrm{I}}=0.8 \mathrm{~V}$ | A or B ports | 75 |  |  | 75 |  | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V} ; \mathrm{V}_{\mathrm{I}}=2.0 \mathrm{~V}$ |  | -75 |  |  | -75 |  |  |
|  |  | $\mathrm{V}_{\text {CC }}=5.5 \mathrm{~V} ; \mathrm{V}_{1}=0$ to 5.5 V |  | $\pm 500$ |  |  | $\pm 500$ |  |  |
| IOFF | Power-off leakage current | $\mathrm{V}_{\mathrm{CC}}=0.0 \mathrm{~V} ; \mathrm{V}_{\mathrm{O}}$ or $\mathrm{V}_{1} \leq 4.5 \mathrm{~V}$ |  |  | $\pm 5.0$ | $\pm 100$ |  | $\pm 100$ | $\mu \mathrm{A}$ |
| IPu/lpd | Power-up/down 3-State output current | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}=2.0 \mathrm{~V} ; \mathrm{V}_{\mathrm{O}}=0.5 \mathrm{~V} ; \\ & \mathrm{V}_{\mathrm{I}}=\mathrm{GND} \text { or } \mathrm{V}_{\mathrm{CC}} ; \mathrm{V}_{\mathrm{OE}}=\mathrm{V}_{\mathrm{CC}} \end{aligned}$ |  |  | $\pm 60$ | $\pm 200$ |  | $\pm 200$ | $\mu \mathrm{A}$ |
| IozH | 3-State output High current | $\mathrm{V}_{\mathrm{CC}}=5.5 \mathrm{~V} ; \mathrm{V}_{\mathrm{O}}=2.7 \mathrm{~V} ; \mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{IL}}$ or $\mathrm{V}_{\mathrm{IH}}$ |  |  | 1.0 | 10 |  | 10 | $\mu \mathrm{A}$ |
| $\mathrm{l}_{\text {OZL }}$ | 3-State output Low current | $\mathrm{V}_{\mathrm{CC}}=5.5 \mathrm{~V} ; \mathrm{V}_{\mathrm{O}}=0.5 \mathrm{~V} ; \mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\text {IL }}$ or $\mathrm{V}_{\mathrm{IH}}$ |  |  | -1.0 | -10 |  | -10 | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\text {CEX }}$ | Output high leakage current | $\mathrm{V}_{\mathrm{CC}}=5.5 \mathrm{~V} ; \mathrm{V}_{\mathrm{O}}=5.5 \mathrm{~V} ; \mathrm{V}_{\mathrm{I}}=\mathrm{GND}$ or $\mathrm{V}_{\mathrm{CC}}$ |  |  |  | 50 |  | 50 | $\mu \mathrm{A}$ |
| lo | Output current ${ }^{1}$ | $\mathrm{V}_{\mathrm{CC}}=5.5 \mathrm{~V} ; \mathrm{V}_{\mathrm{O}}=2.5 \mathrm{~V}$ |  | -50 | -100 | -225 | -50 | -225 | mA |
| $I_{\text {cc }}$ | Quiescent supply current | $\mathrm{V}_{\mathrm{CC}}=5.5 \mathrm{~V}$; Outputs High, $\mathrm{V}_{\mathrm{I}}=$ GND or $\mathrm{V}_{\mathrm{CC}}$ |  |  | 0.2 | 1.5 |  | 1.5 | mA |
|  |  | $\mathrm{V}_{\mathrm{CC}}=5.5 \mathrm{~V}$; Outputs Low, $\mathrm{V}_{\mathrm{I}}=\mathrm{GND}$ or $\mathrm{V}_{\mathrm{CC}}$ |  |  | 8 | 19 |  | 19 |  |
|  |  | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}=5.5 \mathrm{~V} \text {; Outputs 3-State; } \\ & \mathrm{V}_{\mathrm{I}}=\mathrm{GND} \text { or } \mathrm{V}_{\mathrm{CC}} \end{aligned}$ |  |  | 0.1 | 1.0 |  | 1.0 |  |
| $\Delta^{\text {l }}$ c | Additional supply current per input pin ${ }^{2}$ | Outputs enabled, one input at 3.4 V , other inputs at $\mathrm{V}_{\mathrm{CC}}$ or GND ; $\mathrm{V}_{\mathrm{CC}}=5.5 \mathrm{~V}$ |  |  | 0.1 | 1.5 |  | 1.5 | mA |

## NOTES:

1. Not more than one output should be tested at a time, and the duration of the test should not exceed one second.
2. This is the increase in supply current for each input that is at the specified TTL voltage level rather than $\mathrm{V}_{\mathrm{CC}}$ or GND.
3. This is the bus hold minimum overdrive current required to force the input to the opposite logic state.

## 12-bit to 24-bit multiplexed D-type latches (3-State)

## AC ELECTRICAL CHARACTERISTICS

Over recommended operating free-air temperature range (unless otherwise noted)

| SYMBOL | PARAMETER |  | $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{amb}}=25^{\circ} \mathrm{C}$ |  |  | $\mathrm{T}_{\text {amb }}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | FROM (INPUT) | TO (OUTPUT) | MIN | TYP | MAX | MIN | MAX |  |
| tpLH | A or B | B or A | 1 | 2.8 | 4.8 | 1 | 5.6 | ns |
| tphL |  |  | 1 | 2.5 | 5 | 1 | 5.9 | ns |
| tplh | LE | A or B | 1.1 | 3.2 | 4.9 | 1.1 | 5.8 | ns |
| tphL |  |  | 1.1 | 3.2 | 4.9 | 1.1 | 5.3 | ns |
| $\mathrm{t}_{\text {PLH }}$ | SEL (B1) | A | 1.3 | 3.2 | 4.6 | 1.3 | 5.3 | ns |
|  | SEL (B2) | A | 1.1 | 2.8 | 4.9 | 1.1 | 6 | ns |
| $\mathrm{t}_{\text {PHL }}$ | SEL (B1) | A | 1.5 | 3.0 | 4.4 | 1.5 | 4.4 | ns |
|  | SEL (B2) | A | 1.6 | 2.6 | 5.1 | 1.6 | 5.9 | ns |
| $\mathrm{t}_{\text {PZH }}$ | OE | A or B | 1 | 2.9 | 4.7 | 1 | 5.7 | ns |
| $\mathrm{t}_{\text {PZL }}$ |  |  | 1.6 | 2.2 | 5.1 | 1.6 | 5.8 | ns |
| tphz | OE | A or B | 2.2 | 4.1 | 5.4 | 2.2 | 6.4 | ns |
| tpLz |  |  | 1.3 | 3.2 | 4.4 | 1.3 | 4.8 | ns |

## AC SETUP CHARACTERISTICS

Over recommended operating free-air temperature range (unless otherwise noted)

| SYMBOL | PARAMETER | $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{~T}_{\text {amb }}=25^{\circ} \mathrm{C}$ |  | $\mathrm{T}_{\text {amb }}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | MAX | MIN | MAX |  |
| $\mathrm{t}_{\mathrm{w}}$ | Pulse duration, LE1B, LE2B, LEA1B, or LEA2B high | 3.3 |  | 3.3 |  | ns |
| $\mathrm{t}_{\text {su }}$ | Setup time, data before LE1B, LE2B, LEA1B, or LEA2B $\downarrow$ | 1.5 |  | 1.5 |  | ns |
| $t_{n}$ | Hold time, data after LE1B, LE2B, LEA1B, or LEA2B $\downarrow$ | 1 |  | 1 |  | ns |

## 12-bit to 24-bit multiplexed D-type latches (3-State)

## AC WAVEFORMS

$\mathrm{V}_{\mathrm{M}}=1.5 \mathrm{~V}$ for all waveforms
The outputs are measured one at a time with one transition per measurement.


Figure 1. Pulse duration


All input pulses are supplied by generators having the following characteristics: $\mathrm{PRR} \leq 10 \mathrm{MHz}, \mathrm{Z}_{\mathrm{O}}=50 \Omega, \mathrm{t}_{\mathrm{r}} \leq 2.5 \mathrm{~ns}, \mathrm{t}_{\mathrm{f}} \leq 2.5 \mathrm{~ns}$.

Figure 2. Propagation delay times; inverting and non-inverting outputs


Figure 3. Setup and hold times


Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.

Figure 4. Enable and disable times;
low- and high-level enabling

## TEST LOAD CIRCUIT



Figure 5. Test load circuit

detail X


DIMENSIONS (mm are the original dimensions)

| UNIT | $\mathbf{A}$ <br> max. | $\mathbf{A}_{\mathbf{1}}$ | $\mathbf{A}_{\mathbf{2}}$ | $\mathbf{A}_{\mathbf{3}}$ | $\mathbf{b}_{\mathbf{p}}$ | $\mathbf{c}$ | $\mathbf{D}^{(1)}$ | $\mathbf{E}^{(1)}$ | $\mathbf{e}$ | $\mathbf{H}_{\mathbf{E}}$ | $\mathbf{L}$ | $\mathbf{L}_{\mathbf{p}}$ | $\mathbf{Q}$ | $\mathbf{v}$ | $\mathbf{w}$ | $\mathbf{y}$ | $\mathbf{z}^{(1)}$ | $\boldsymbol{\theta}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| mm | 2.8 | 0.4 | 2.35 | 0.25 | 0.3 | 0.22 | 18.55 | 7.6 | 0.635 | 10.4 | 1.4 | 1.0 | 1.2 | 0.25 | 0.18 | 0.1 | 0.85 | $8^{\circ}$ |
| 0.20 | 0.2 | 0.2 | 0.13 | 18.30 | 7.4 | 0.40 | 10.1 | 1.4 | 0.6 | $0^{\circ}$ |  |  |  |  |  |  |  |  |

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

| OUTLINE <br> VERSION | REFERENCES |  |  |  | EUROPEAN <br> PROJJECTION | ISSUE DATE |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
|  | IEC | JEDEC | EIAJ |  |  |  |
| SOT371-1 |  | MO-118AB |  |  | $-93-11-02$ |  |


detail X
MSA40O

Dimensions in mm.

## NOTES

Data sheet status

| Data sheet <br> status | Product <br> status | Definition [1] |
| :--- | :--- | :--- |
| Objective <br> specification | Development | This data sheet contains the design target or goal specifications for product development. <br> Specification may change in any manner without notice. |
| Preliminary <br> specification | Qualification | This data sheet contains preliminary data, and supplementary data will be published at a later date. <br> Philips Semiconductors reserves the right to make chages at any time without notice in order to <br> improve design and supply the best possible product. |
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[1] Please consult the most recently issued datasheet before initiating or completing a design.

## Definitions

Short-form specification - The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.
Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.
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